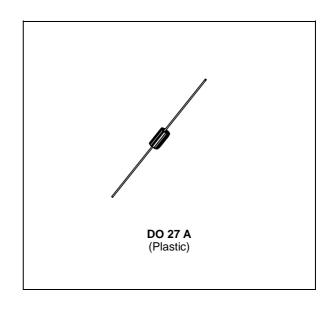
# BYT 03-200 →400

# FAST RECOVERY RECTIFIER DIODES

- VERY LOW REVERSE RECOVERY TIME
- VERY LOW SWITCHING LOSSES
- LOW NOISE TURN-OFF SWITCHING



#### **SUITABLE APPLICATIONS**

- FREE WHEELING DIODE IN CONVERTERS AND MOTOR CONTROL CIRCUITS
- RECTIFIER IN S.M.P.S.

# **ABSOLUTE MAXIMUM RATINGS** (limiting values)

Symbol	Parameter	Value	Unit	
I <sub>FRM</sub>	Repetive Peak Forward Current	$t_p \le 10 \mu s$	60	Α
I <sub>F (AV)</sub>	Average Forward Current*	$T_{a=}65^{\circ}C$ $\delta = 0.5$	3	А
I <sub>FSM</sub>	Surge non Repetitive Forward Current	t <sub>p</sub> = 10ms Sinusoidal	60	А
P <sub>tot</sub>	Power Dissipation *	T <sub>a =</sub> 65°C	4.2	W
T <sub>stg</sub> T <sub>j</sub>	Storage and Junction Temperature Range	- 40 to + 150 - 40 to + 150	°C	

Symbol	Parameter		Unit		
	Tarameter	200	300	400	
$V_{RRM}$	Repetitive Peak Reverse Voltage	200	300	400	٧
V <sub>RSM</sub>	Non Repetitive Peak Reverse Voltage	220	330	440	<b>V</b>

#### THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R <sub>th (j - a)</sub>	Junction-ambient*	20	°C/W

<sup>\*</sup> On infinite heatsink with 10mm lead length.

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# **ELECTRICAL CHARACTERISTICS**

# STATIC CHARACTERISTICS

Synbol	Tes	Min.	Тур.	Max.	Unit	
I <sub>R</sub>	T <sub>j</sub> = 25°C	$V_R = V_{RRM}$			20	μΑ
	T <sub>j</sub> = 100°C				0.5	mA
V <sub>F</sub>	T <sub>j</sub> = 25°C	I <sub>F</sub> = 3A			1.5	V
	T <sub>j</sub> = 100°C				1.4	

# RECOVERY CHARACTERISTICS

Symbol		Min.	Тур.	Max.	Unit			
t <sub>rr</sub>	T <sub>j</sub> = 25°C	I <sub>F</sub> = 1A	$di_F/dt = -15A/\mu s$	$V_R = 30V$			55	ns
		I <sub>F</sub> = 0.5A	I <sub>R</sub> = 1 A	$t_{rr} = 0.25A$			25	

# TURN-OFF SWITCHING CHARACTERISTICS - Without Series Inductance

Symbol		Test Conditions						Unit
t <sub>IRM</sub>	$di_F/dt = -50A/\mu s$	T <sub>j</sub> = 100 °C	V <sub>CC</sub> = 200V	$I_F = 3A$		35	50	ns
I <sub>RM</sub>	$di_F/dt = -50A/\mu s$	L <sub>P</sub> ≤ 0.05μH				1.5	2	Α

To evaluate the conduction losses use the following equations:

$$V_F = 1.1 + 0.050 I_F$$
  $P = 1.1 \times I_{F(AV)} + 0.050 I_{F^2(RMS)}$ 

Figure 1. Maximum average power dissipation versus average forward current.

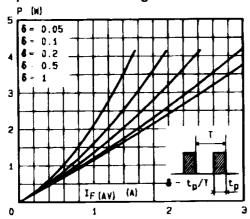


Figure 3. Thermal resistance versus lead length.

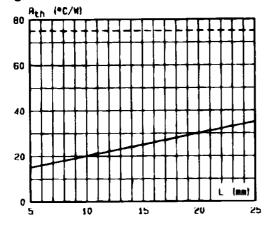


Figure 4. Transient thermal impedance junction-ambient for mounting  $n^2$  versus pulse duration (L = 10 mm).

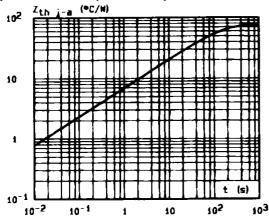
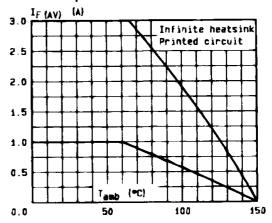


Figure 2. Average forward current versus ambient temperature.



Mounting n°1
INFINITE HEATSINK

Mounting n°2 PRINTED CIRCUIT

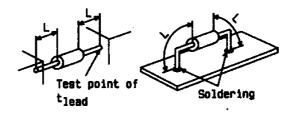


Figure 5. Peak forward current versus peak forward voltage drop (maximum values).

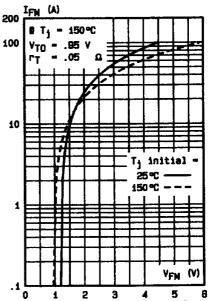


Figure 7. Recovery time versus dif/dt.

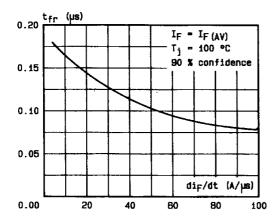


Figure 8. Peak forward voltage versus dif/dt.

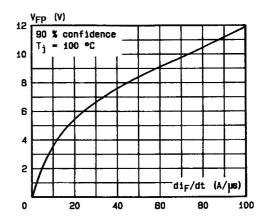


Figure 9. Peak forward voltage versus di<sub>F</sub>/dt.

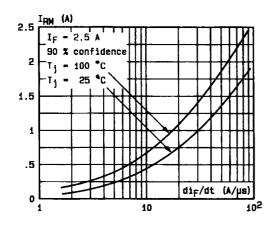


Figure 10. Recovery charge versus di⊧/dt (typical values).

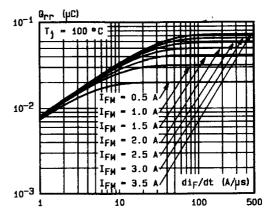


Figure 11. Dynamic parameters versus junction temperature.

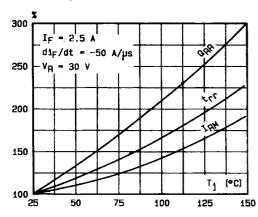
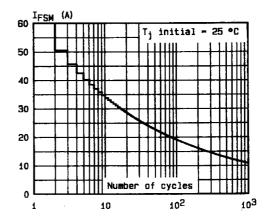
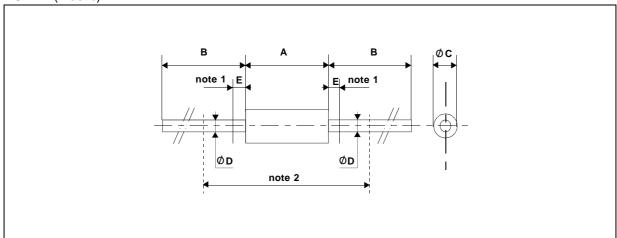


Figure 12. Non repetitive surge peak current versus number of cycles.



#### **PACKAGE MECHANICAL DATA**

#### DO 27A (Plastic)



	DIMENSIONS		DIMENSIONS							
REF.	REF. Millimeters		Millimeters Inche		ters Inches		NOTES			
	Min.	Max.	Min.	Max.						
Α		9.80		0.385	1 - The lead diameter Ø D is not controlled over zone E					
В	26		1.024		The lead diameter & B is not controlled over zone E					
ØC		5.10			2 - The minimum axial lengh within which the device may be					
ØD		1.28		0.050	placed with its leads bent at right angles is 0.59"(15 mm)					
Е		1.25		0.049						

Cooling method: by convection (method A) Marking: type number; white band indicates cathode Weight: 1g

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